

NOT RECOMMENDED FOR NEW DESIGN CONTACT US



P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary (Typ. @ V_{GS} = -4.5V, T_A = +25°C)

BV _{DSS}	RDS(ON)	Qg	Q_{gd}	lσ
-12V	0.065Ω	2.5nC	0.6nC	-3.3A

Description

This new generation MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Battery managements
- Load switches
- Battery protections

Features

- LD-MOS Technology with the Lowest Figure of Merit: $R_{DS(ON)} = 0.065\Omega \ to \ Minimize \ On-State \ Losses$ $Q_g = 2.5nC \ for \ Ultra-Fast \ Switching$
- V_{gs(TH)} = -0.5V Typ. for a Low Turn-On Potential
- CSP with Footprint 1.0mm x 1.0mm
- Height = 0.62mm for Low Profile
- ESD = 3kV HBM Protection of Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at

https://www.diodes.com/products/automotive/automotive-products/.

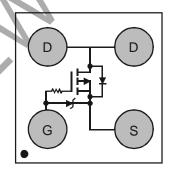
 This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: U-WLB1010-4
- Terminal Connections: See Diagram Below
- Weight: 0.0018 grams (Approximate)

U-WLB1010-4



Top View Equivalent Circuit



Ordering Information (Note 4)

Part Number	Packago	Packing		
Part Number	Package	Qty.	Carrier	
DMP1081UCB4-7	U-WLB1010-4	3,000	Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information

U-WLB1010-4



7A = Product Type Marking Code YM = Date Code Marking Y = Year (ex: J = 2022) M = Month (ex: 9 = September)

Date Code Kev

Year	2016		2022	2023	2024	2025	2026	2027	2028	2029	2030	2031
Code	D		J	K	L	М	N	0	Р	R	S	Τ
Month	lan											
MOHUI	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		V _{DSS}	-12	V
Gate-Source Voltage	AX	V _{GSS}	-6	V
Continuous Drain Current (Note 5) V _{GS} = -4.5V	Steady $T_A = +25^{\circ}$ C $T_A = +70^{\circ}$ C	_ ID _	-3.3 -2.7	А
Continuous Drain Current (Note 5) V _{GS} = -2.5V	Steady $T_A = +25^{\circ}$ C State $T_A = +70^{\circ}$ C		-3.0 -2.4	А
Pulsed Drain Current (Note 6)		I _{DM}	20	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 7)	PD	0.82	W
Thermal Resistance, Junction to Ambient @TA = +25°C (Note 7)	Reja	150	°C/W
Thermal Resistance, Junction to Case @Tc = +25°C (Note 7)	Rejc	42.66	°C/W
Power Dissipation (Note 5)	PD	1.59	W
Thermal Resistance, Junction to Ambient @T _A = +25°C (Note 5)	Reja	80.29	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Notes:

- Device mounted on FR-4 material with 1inch² (6.45cm²), 2oz. (0.071mm thick) Cu.
 Repetitive rating, pulse width limited by junction temperature.
 Device mounted on FR-4 PCB with minimum recommended pad layout, single sided.



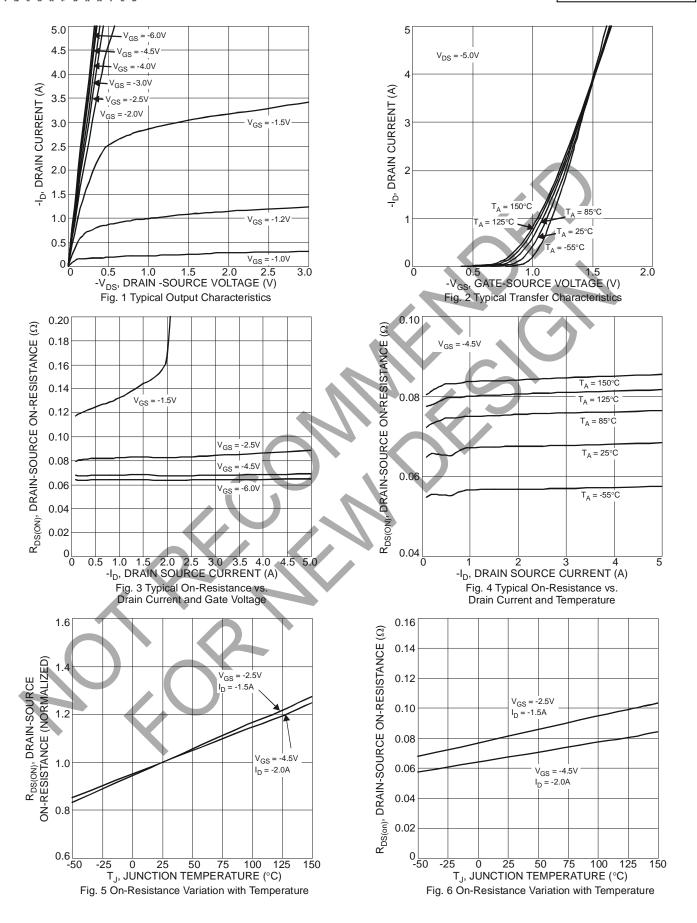
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	-12	•	-	٧	$V_{GS} = 0V, I_D = -250\mu A$	
Gate-Source Breakdown Voltage	BVGSS	-6.0	0	-	٧	$V_{DS} = 0V, I_{G} = -250\mu A$	
Zero Gate Voltage Drain Current TJ = +25°C	IDSS	-	•	-1	μΑ	$V_{DS} = -9.6V, V_{GS} = 0V$	
Gate-Source Leakage	Igss	-	ı	-100	nA	$V_{GS} = -6V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)	ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(TH)}	-0.35	-0.5	-0.65	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
		-	0.065	0.08		$V_{GS} = -4.5V$, $I_{D} = -500mA$	
Static Drain-Source On-Resistance	Dro(ou)	-	0.077	0.1	Ω	$V_{GS} = -2.5V$, $I_{D} = -500mA$	
Static Dialit-Source Off-Resistance	RDS(ON)	-	0.108	0.13	Δ2	$V_{GS} = -1.5V$, $I_{D} = -500mA$	
		-	0.4	10		$V_{GS} = -0.9V, I_{D} = -100mA$	
Forward Transfer Admittance	Y _{fs}	-	4	•	S	$V_{DS} = -6V, I_{D} = -500mA$	
Diode Forward Voltage	VsD	-	-0.6	-1.0	V	$V_{GS} = 0V, I_{S} = -500mA$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss	-	213	350		V-= 6V V 0V	
Output Capacitance	Coss	-	119	250	pF	$V_{DS} = -6V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	Crss	-	54.4	90		1 = 130(0112	
Total Gate Charge	Q_g	-	2.5	5			
Gate-Source Charge	Q_{gs}	-	0.3	<u>-</u>	nC	$V_{GS} = -4.5V, V_{DS} = -6V,$	
Gate-Drain Charge	Q_{gd}	-	0.6	-	HC	$I_D = -500 \text{mA}$	
Gate Charge at Vтн	Q _{g(TH)}	-	0.15	-			
Turn-On Delay Time	td(ON)	1	16.7	1			
Turn-On Rise Time	tr		20.6) -	. 20	$V_{DS} = -6V$, $V_{GS} = -2.5V$,	
Turn-Off Delay Time	tD(OFF)		38.4	-	ns	$R_G = 20\Omega, I_D = -500 \text{mA}$	
Turn-Off Fall Time	tr	-	28.4	<u> </u>			
Reverse Recovery Charge	Q _{RR}	-	2.0	-/	nC	$V_{DD} = -4.0V$, $I_F = -0.5A$,	
Reverse Recovery Time	trr	-	9.5	-	ns	di/dt =100A/µs	

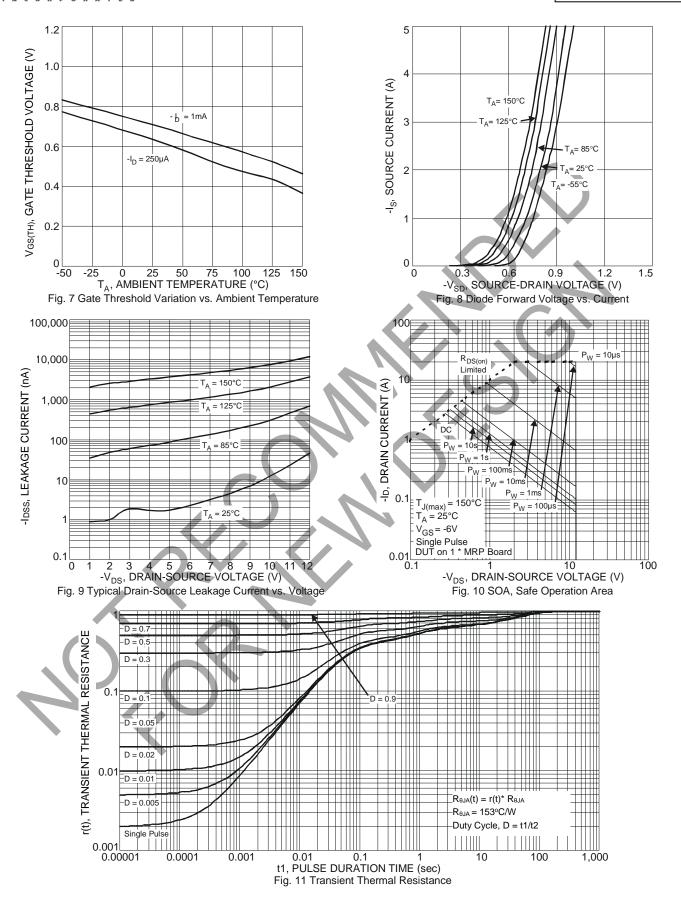
Notes:

- 8. Short duration pulse test used to minimize self-heating effect.
 9. Guaranteed by design. Not subject to production testing.







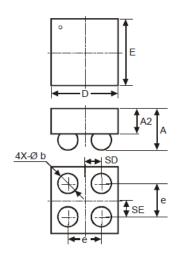




Package Outline Dimension

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-WLB1010-4

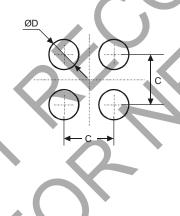


U-WLB1010-4					
Dim	Min	Max	Тур		
D	0.95	1.05	1.00		
Е	0.95	1.05	1.00		
Α	_	0.62	_		
A2	_	- (0.38		
b	0.25	0.35	0.30		
е	_		0.50		
SD	- (_	0.25		
SE	-		0.25		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-WLB1010-4



Dimensions	Value (in mm)
С	0.50
<u> </u>	0.25



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